Draft Specification For UV-C Series

BRT-B35LD7E1CSC

Features

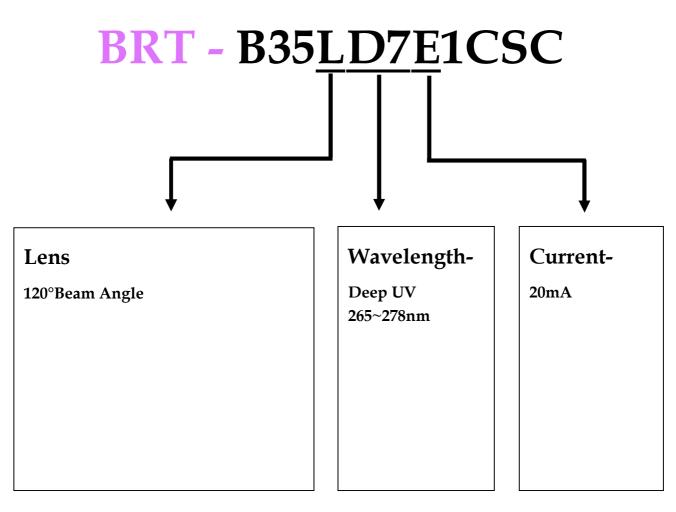
- Deep Ultraviolet LED
- Dimension : 3.45mm(L)×3.45mm(W)
- All Metal Design Cu Substrate
- View Angle 120°
- Low thermal resistance

Applications

- Disinfection
- Chemical and Biological analysis

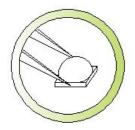


General Information





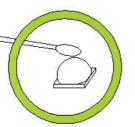
Do not poke the Led Lens with sharp object



Hold the Led only by the substrate



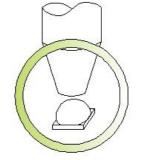
Do not stack assembled PCB



Clean the LED surface with cotton bud



Do not hold the Led with hand



Use pick and place nozzle per recommendation in data sheet



Do not press or push the Led Lens

Absolute Maximum Ratings

Parameter	Symbol	Value	Unit	
Power Dissipation	Р	0.3	W	
Forward Current	$\mathbf{I}_{\mathbf{F}}$	30	mA	
Thermal Resistance, Junction-Case	R _{th} , J-C1	15	°C/W	
Operating Temperature Range	T _{opr}	- 40°C to + 60°C		
Storage Temperature Range	T _{stg}	- 40°C to + 100°C		
Soldering Condition	T _{sol}	260°C For 5 Seconds		

Note: 1. The thermal resistance value is measured with MCPCB (Star).

Initial Electrical/Optical Characteristics

Parameter	Symbol	Min	Тур	Max	Test Condition	Unit
Peak wavelength	λ_p	265	-	278		nm
Radiant Flux	Φ_{e}	1.5	3	-		mW
Radiant Irradiance	Ee	-	0.6	-	$I_F = 20 m A$	mW/cm^2
Forward Voltage	VF	-	6.5	10		V
Spectra half-width	Δλ	-	15	-		nm

Note

1. Forward voltage measurement allowance is ± 0.2 V.

2. Radiant flux measurement allowance is $\pm 10\%$.

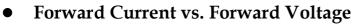
3. Irradiance tested at a distance 10mm from lens top.

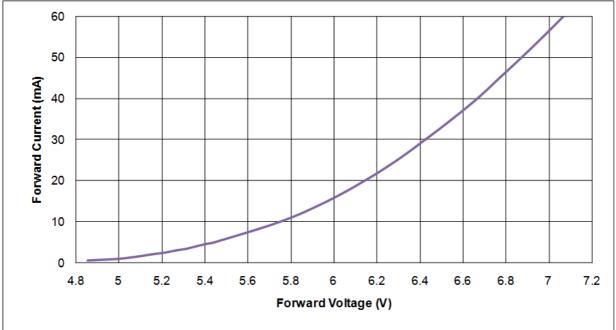
4. Wavelength measurement allowance is ± 3nm.

(Tj=25℃)

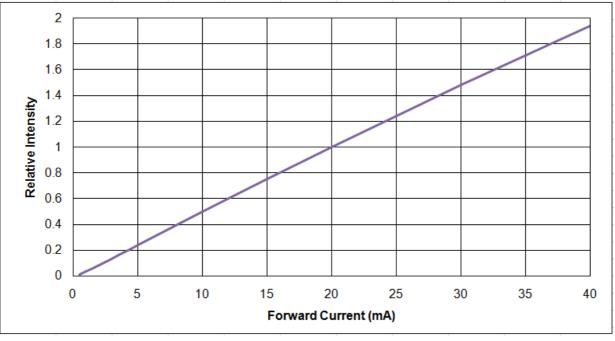
(Tj=25℃)

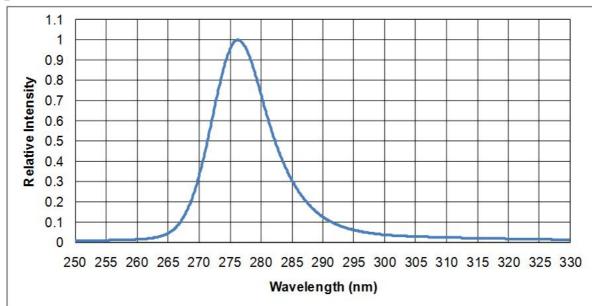
Characteristic Diagram





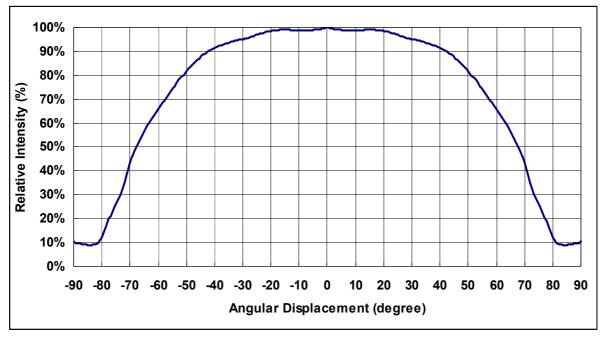
• Relative Intensity vs. Forward Current





• Spectral Power Distribution

• Typical Radiation Pattern



• Bin Code List for Reference

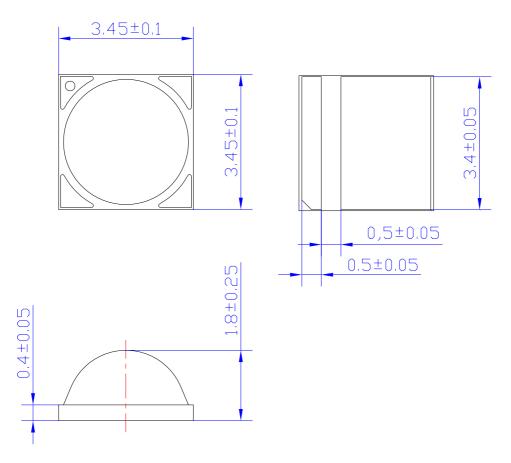
						(Tj=25℃)
Item	Bin code	Symbol	Condition	Min.	Max.	Unit
Forward Voltage ¹	Е	V _F I _F =20 [mA]	I _F =20 [mA]	5	6	
	F			6	7	
	G			7	8	V
	Н			8	9	
	J		9	10		
Radiant Flux ²	A15	$\Phi_{ m e}$ I _F =	I _F =20 [mA]	1.5	2.5	mW
Kaulant Flux-	A25		$I_F = 20 [IIIA]$	2.5	4	11177

Bin Rank : V_F - Φ_e

Note

- 1. Forward voltage measurement allowance is ± 0.2 V.
- 2. Radiant flux measurement allowance is $\pm 10\%$.

Outline Dimension





• Pad Configuration

		PAD	Function
2 1	1 2	1	Cathode
R IA		2	Anode • Thermal

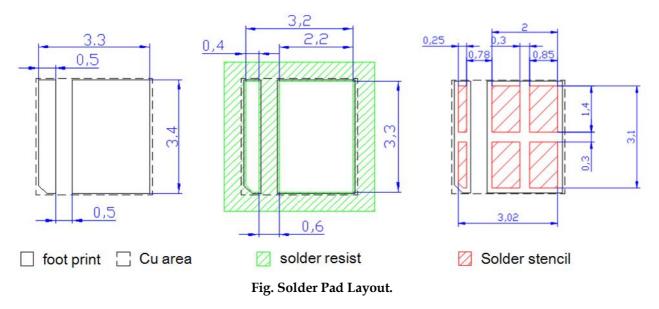
ТОР

BOTTOM

Fig. Pad configuration.

Note: Please don't put conductive material on the top surface of LEDs.

Recommended Solder Pattern

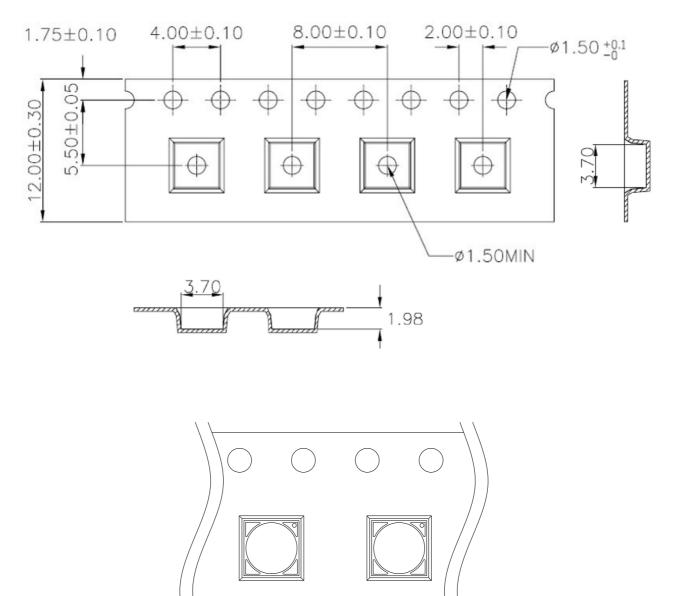


Shipping Package Style

Tapping Dimension Packaging Specification

- Moisture proof bag.
- 1 Reel/bag.
- Q'ty: 700(MAX)/Reel

Unit : mm



Label Formation

F	P/N:	****	BIN	Rank	÷	XXXXXXXXX	хх
L	LOT:	****		Q't y	:	XXXXPCS	ххх

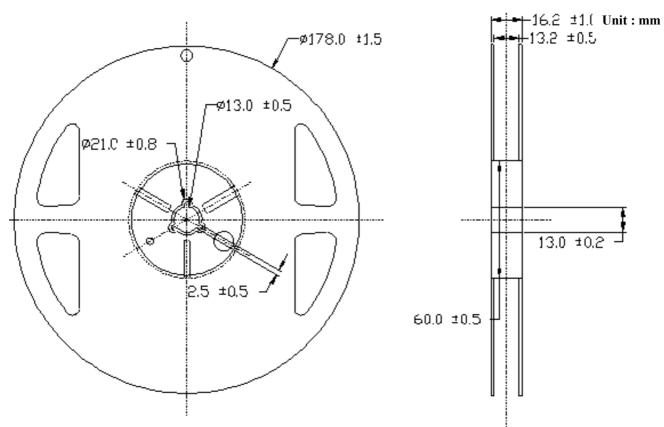
75mm*8mm

Package

Box Type	Dimension (mm)	Reel/Box	120°Lens Type(Pcs)
Small Box(S)	230x85x265	5 Reel/Box	3500
Middle Box(M)	470x265x270	30 Reel/Box	21000
Large Box(L)	470x435x270	50 Reel/Box	35000

Reel Packaging :

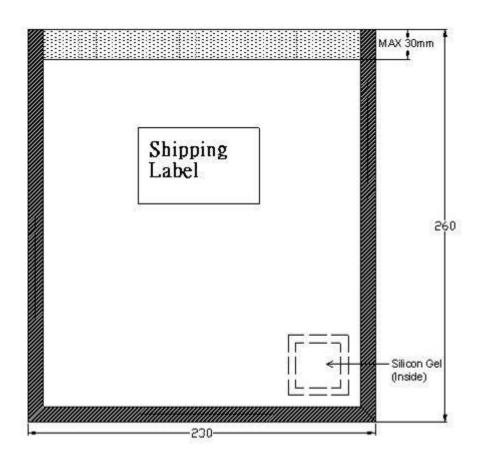
Reel Part :



The information in this document is subject to change without notice.

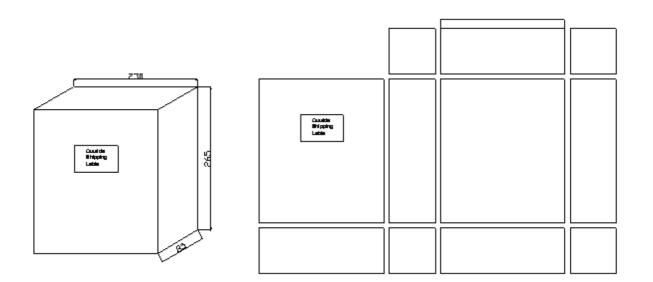
Anti Statistic Bag:

Unit:mm



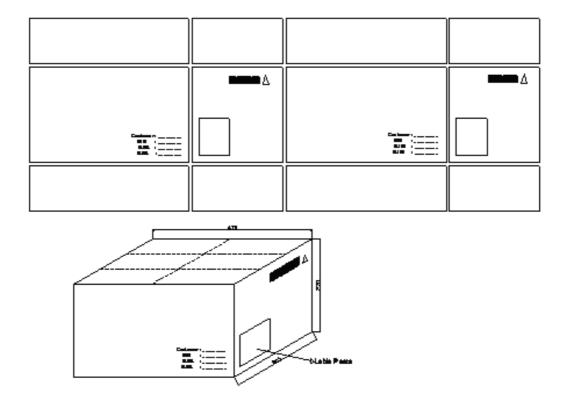
Small Box

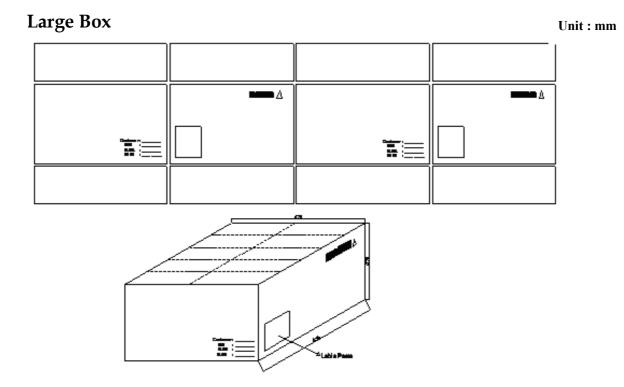
Unit : mm



Middle Box

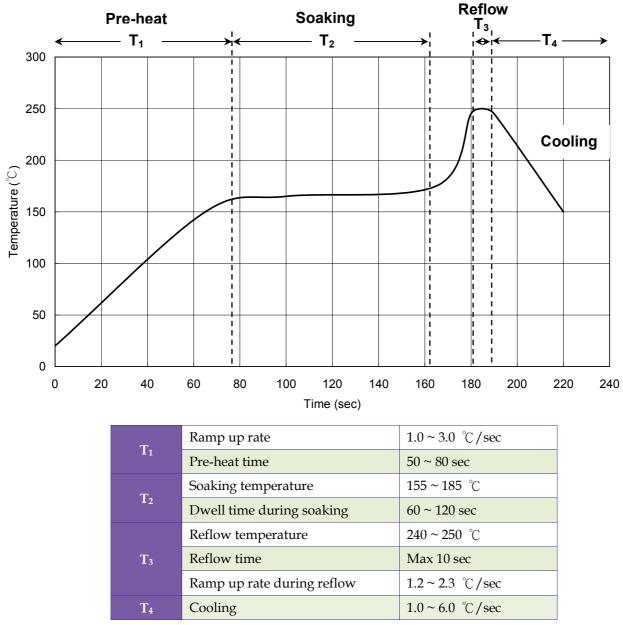
Unit : mm





Recommended Solder Profile

Soldering Recommended soldering conditions:



Note: Suggest using Sn96Ag3Cu0.5 lead free solder.

Cleaning

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LED if necessary.

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